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# Morphology Analysis of Si Island Arrays on Si(001)

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**Abstract** The formation of nanometer-scale islands is an important issue for bottom-up-based schemes in novel electronic, optoelectronic and magnetoelectronic devices technology. In this work, we present a detailed atomic force microscopy analysis of Si island arrays grown by molecular beam epitaxy. Recent reports have shown that self-assembled distributions of fourfold pyramid-like islands develop in 5-nm thick Si layers grown at substrate temperatures of 650 and 750°C on HF-prepared Si(001) substrates. Looking for wielding control and understanding the phenomena involved in this surface nanostructuring, we develop and apply a formalism that allows for processing large area AFM topographic images in a shot, obtaining surface orientation maps with specific information on facets population. The procedure reveals some noticeable features of these Si island arrays, e.g. a clear anisotropy of the in-plane local slope distributions. Total island volume analysis also indicates mass transport from the substrate surface to the 3D islands, a process presumably related to the presence of trenches around some of the pyramids. Results are discussed within the framework of similar island arrays in homoepitaxial and heteroepitaxial semiconductor systems.

**Keywords** Silicon nanostructures · Molecular beam epitaxy · Self-assembly · Scanning probe microscopy · Morphology analysis

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# Introduction

The growth of self-assembled island arrays on semiconductor substrates has been reported and analyzed extensively because of their high technological interest [1-3]; nevertheless, the exact role of critical factors of the growth process still remains under debate in some relevant material systems. Keeping in mind the device applications, many of the efforts in the last years have been focused to develop processes to control the size, shape and distribution of the nanostructures, often by combining self-assembly and lithography-patterned templates, thus becoming the morphology characterization at the nanoscale increasingly important. To carry out a deep analysis of the morphology in nanoscale structures, it is important not only to have adequate probing techniques, but also to access efficient analysis tools in order to extract and exploit the information of the experimental data. We have developed a topographic image processing procedure, based on polynomial interpolating functions, with successful applications in the analysis of thin film growth at the nanoscale [4]. We combine here this algorithm with atomic force microscopy (AFM) measurements to investigate in detail the morphology of Si islands arrays grown by molecular beam epitaxy (MBE) on HF-treated Si(001) surfaces [5].

We have recently shown [5] that a rich variety of surface morphologies, namely island distributions, ridge networks and pyramidal nanohole arrays, can be produced by homoepitaxy of thin (5–25 nm) Si layers, under suitable conditions of sample preparation (HF-passivation) and film growth. Such nanostructured surfaces are attractive, for instance, as potential templates for the growth of quantum dot arrays. Choosing an appropriate growth conditions window, the surface layer morphology evolves following the "islands formation  $\rightarrow$  ridges by islands coalescence  $\rightarrow$  two dimensional growth" path. This sequence ends up in the step-flow growth regime, generating optimum flat morphology samples for thick enough ( $\geq 100$  nm) Si layers [5]. Among the nanoscale distributions observed, we find that rather homogeneous arrays of pyramid-like islands can be achieved for 5-nm thick Si layers, in which the size of the entities and the order of their assembly show an acute, though reproducible, dependence on the substrate temperature during growth. These island arrays also exhibit interesting similarities with other semiconductor systems, regarding self-ordering, island shapes and sizes [5].

The mechanisms responsible for the formation of these Si pyramids arrays are not yet well established. Provided that mismatch strain is ruled out, which is often ascribed as the cause for 3D growth in the case of heteroepitaxial systems, the origin of this type of nanostructures in homoepitaxy has been generally explained in terms of anisotropic surface fluxes caused, for instance, by step edge barriers [6, 7]. Trying to gain insights into the phenomena that play a key role on the formation of these Si island arrays, we have carried out a detailed study of their morphology features, in particular island size and facet distribution. Taking into account the results presented here, we believe that our formalism should be also useful for the study of other material systems with similar morphological features. Note that two dimensional (2D) distributions of faceted islands, sharing some of the features of the above described Si nanostructure arrays, have been reported [1-3]for quite a few material systems, like for instance Si grown on thin  $Si_{1-x}C_x$  films [8], selective area epitaxial layers grown on windows opened in thin Si-oxide layers on Si(001) [9, 10], Ge/Ge(001) [11] and GaSb/GaSb(001) [12] homoepitaxial layers or Ge and  $Si_{1-x}Ge_x$  alloys grown on Si(001) [1-3, 13-17].

# Experimental

### Film Growth and Characterization

The morphology analysis carried out along this work has been performed over AFM images measured in two types of samples. Both of them correspond to Si layers of the same nominal deposited thickness (t = 5 nm), grown by MBE on B-doped singular Si(001) single crystals, for which manufacturer specifications warrant a polar angle miscut  $\alpha \le \pm 0.5^{\circ}$ . Substrate surfaces are prepared by exposure to the vapor of an aqueous HF solution followed by radiative annealing in ultra-high vacuum. The growth temperature,  $T_g$ , denotes here the temperature of the substrate surface, once it has been measured at the center of test samples by radiation thermometry and established its correlation to the substrate holder thermocouple reading. Substrate preparation and film growth conditions have been the same in all cases except for the growth substrate temperature,  $T_{\rm g} = 650$  and  $T_{\rm g} = 750^{\circ}$ C, respectively. Pregrowth annealing temperature is 10°C above the selected  $T_{g}$ . Silicon is deposited from an electron-beam evaporator feedback controlled by electron impact emission spectroscopy flux measurements. Actual growth rates at sample position are calibrated by a quartz crystal thickness monitor and X-ray reflectivity measurements on test samples, using Si growth rates values of 0.25 Å/s for the experiments here discussed. Low-energy electron diffraction (LEED), Auger electron spectroscopy (AES) and reflection high-energy electron diffraction (RHEED) are routinely used to provide in situ information on the surfaces of the substrates and deposited layers. For both  $T_{\rm g}$ , the RHEED patterns observed after Si growth showed arrowhead features characteristic of a faceted surface, together with a  $2 \times 1$ reconstruction, while the AES spectra indicate clean Si surfaces. Further details on these topics can be found elsewhere [5].

To investigate the surface morphology of the Si/Si(001) samples, ex situ tapping-mode AFM images were recorded, using WSxM software by Nanotec [18]. We use supersharp silicon tips (nominal tip radius  $r \sim 2$  nm and high aspect ratio ~100:1). Lateral resolution is estimated to be better than 4 nm. In addition, we register the images at very low scanning frequencies (0.1–0.4 lines/s) in order to avoid oscillations of the feedback system (or instrumental noise) that could be amplified by the derivative procedure, degrading the reliability of the slope analysis, as suggested in previous works [19].

Local Slope Evaluation Formalism

We have recently developed a neat procedure to obtain the local surface slope values relative to the substrate surface plane, m, averaged over the pixel area [4]. Briefly, we use mathematical objects that produce a 2D interpolation function of an AFM image. These objects operate fitting polynomial curves among image pixels, explicitly obtained by Lagrange's interpolation classical formalism. The objects then transform the digital AFM image into a continuous function, derivable over the whole space. This function can be considered as a suitable topographic mold, denoted here as a continuous function  $h(\mathbf{r}, t)$ . We use third-order interpolation (cubic polynomial fitting) as optimal fitting condition [4]. Local surface slopes, m, can be directly obtained from the dot product between the unit vector normal to each surface **r** point,  $\mathbf{n} \equiv (n_x, n_y, n_z) \propto |-\nabla_x h(\mathbf{r}), -\nabla_y h(\mathbf{r}), 1|$ and the substrate surface unit vector, [001] in this case, through the formula  $m = \tan(\cos^{-1}(\mathbf{n} \cdot [001]/||\mathbf{n}||))$ . Quantitative information of the sample surface facets and their arrangement can be extracted plotting the *in-plane* angular

slope distributions,  $N_{\alpha}(m)$ , sometimes referred to as surface orientation maps [20, 21]. We define here the (x, y) plane of the map as a polar plot, in which the angular coordinate  $\varphi = \tan^{-1}(n_x/n_y)$  is the azimuth angle of the normal unit vector at each surface point  $\mathbf{r}$ , and the slope value *m* is plotted as the radial coordinate. The distribution  $N_{\omega}(m)$  allows to quantify and compute globally the in-plane orientation of the local slope values of an image as a whole and can be used, for instance, to follow the evolution of particular features of the facets in samples obtained under different experimental conditions (film thickness, substrate temperature during growth,...) [20, 21]. The resulting slopes distribution is defined as  $N(m) = \sum_{\phi=0}^{2\pi} N_{\phi}(m)$ . A Gaussian fitting of the intensity peaks of N(m) can then be performed, accounting for the relative population of facets as the ratio of their intensity maxima.

#### **Results and Discussion**

Figure 1 shows AFM images of the surface morphology of Si layers (t = 5 nm) grown at substrate temperatures of  $T_{\rm g} = 650$  (Fig. 1a) and  $T_{\rm g} = 750^{\circ}$ C (Fig. 1b). Let us briefly comment some of the similarities and differences between them. Both surfaces exhibit arrays of 3D islands, which are mostly regular fourfold pyramids with square or rectangular bases, their edges preferentially running along the close-packed Si <110> directions [5]. Occasionally, two or more of these pyramid-like islands have coalesced, mainly along the corners. Representative results of the selfcorrelation function analysis performed on several AFM images are displayed as insets in Fig. 1a and 1b, for the respective sample growth temperature  $(T_g = 650 \text{ and }$  $T_{g} = 750^{\circ}$ C). They clearly show that both island arrays exhibit a remarkable degree of order [4], which can be interpreted as indicative of self-assembly or self-organizing processes. We should note, however, that this study was carried out on selected image portions, where we tried to minimize the presence of coalesced island ensembles, because of their disturbing effects.

Significant and reproducible differences between the two sample morphologies are also observed. A simple visual inspection of the AFM images indicates that the number of 3D islands per unit area is higher for  $T_g = 650^{\circ}$ C (Fig. 1a) than for  $T_g = 750^{\circ}$ C (Fig. 1b), while islands are larger (in height and lateral size) and more separated for  $T_g = 750^{\circ}$ C. Such assessments are confirmed by numerical analyses of many island profiles [5]. If we define now the distance between islands ( $\lambda$ ) as the mean minimal distance among island centers in each type of array, we have calculated their values, averaging over a large number of AFM images, to be  $\lambda = 280 \pm 25$  nm for layers grown at  $T_g = 650^{\circ}$ C and  $\lambda = 475 \pm 35$  nm for



**Fig. 1** AFM topography images  $(5 \times 5 \ \mu\text{m}^2)$  of Si pyramid-like arrays obtained growing nominally 5-nm thick Si layers on Si(001) substrates at different growth temperatures: **a**  $T_g = 650^{\circ}\text{C}$  and **b**  $T_g = 750^{\circ}\text{C}$ . The insets correspond to the respective self-correlation functions taken in sample regions of  $2 \times 2 \ \mu\text{m}^2$ , revealing the quite regular order of both arrays

 $T_{\rm g} = 750^{\circ}$ C. In order to analyze the slopes of the pyramids lateral facets and their occurrence for the two growth temperatures, local slope maps (see Fig. 2a, c) have been produced from the AFM images, and the resulting  $N_{\varphi}(m)$  distributions are plotted in Fig. 2b and d. Data shown in Fig. 2 correspond to the AFM images presented in Fig. 1. As explained in section "Local Slope Evaluation Formalism", the larger the facet population, the stronger the intensity at the corresponding position in the  $N_{\varphi}(m)$  distribution. The polar plots confirm that most of the island sidewall facets in the arrays lie along the x and y axes of the surface orientation maps (i.e., along the two orthogonal <110> directions of the Si(001) substrate surface), and a noticeable feature of the  $N_{\varphi}(m)$  distributions shown in Fig. 2b and d is their asymmetry.

Let us examine first the results of Si layers grown at  $T_g = 650^{\circ}$ C (Fig. 2b). The behavior along the *x* and *y* axes is clearly asymmetric. Along *x*, there are two sharp intensity peaks that correspond to the slope (*m*) values associated with angles of 20° ({114} facets). A 3D representation (intensity versus *x*–*y* positions) of one of these peaks is shown as an inset in Fig. 2 (upper right panel); its Gaussian fitting is also displayed. Along the *y* axis, in contrast, the intensity is not sharply concentrated in a particular *m* value, but appears broadly distributed within the range of 20° to 35° angles. Therefore, most of the facets along the *x* axis are {114}, while along *y* there are {114}, {113} and {112}



**Fig. 2** Local slope maps of the AFM images of Fig. 1 for  $T_g = 650^{\circ}$ C (**a**) and  $T_g = 750^{\circ}$ C (**c**), and their respective *in-plane* local slope distributions, (**b**) and (**d**). The different types of facet planes present in each orientation map are marked schematically by hexagons ((119), ~8°), *squares* ((114), ~20°), *triangles* ((113), ~25°) and *open circles* ((112), ~35°); only one from each type is marked. The insets in the *right panel* show: the Gaussian fit of a spot of the *in-plane* local slope distribution (*upper inset*); a zoomed view (taken from (**c**),  $T_g = 750^{\circ}$ C) of a single island local slope map, showing rounded corners connecting facets and with the different facet areas marked (*middle inset*); topography linescan profiles along two representative pyramids of the AFM images of Fig. 1, i.e. produced at  $T_g = 650$  and 750°C (*lower inset*); the corresponding pyramids appear marked by circles in (**a**) and (**c**)

facets present. The slopes of the island facets along x are then lower than along the y axis. Still another asymmetry is found analyzing the relative population of each facet type appearing in the AFM image. Adding the intensity observed for a given m value over the whole angular coordinate in the  $N_{\varphi}(m)$  distribution, we find that approximately 60% of the total intensity corresponds to low slope facets (20°, {114}) and only 20% is associated with higher slope facets (25°–35° angles, {113}, {112}). The remaining 20% corresponds to the diffuse intensity background, lying mainly between the peaks of the  $N_{\varphi}(m)$  distribution. Such weak signals do not correspond to well defined island facets, but to the local slope values of rounded corners in the pyramidal islands; see e.g. the slope map of a single island displayed as an inset in Fig. 2 (middle right panel).

The behavior observed for the islands array of Si layers grown at  $T_g = 750^{\circ}$ C (Fig. 2d) is slightly different, although the asymmetry along the *x* and *y* axes is also present. Along *x*, we find again two sharps peaks at the *m* positions associated with 20° angles, indicating that most of the islands sidewall facets are {114} also in this case. Along the *y* axis, as in the  $T_g = 650^{\circ}$ C case, there is certain intensity broadening toward higher *m* values (in the range of 20°–25° angles on one side, and 25°–35° angles on the other side). Thus, for both  $T_{g}$ , steeper facets develop along one of the <110> directions. Additionally, island facets are better defined for  $T_g = 750^{\circ}$ C, as demonstrated by the two sharp peaks observed along the y axis, corresponding to angles of  $25^{\circ}$  (i.e., {113} facets) on one side and  $35^{\circ}$  (i.e., {112} facets) on the other side. There is an asymmetry then between opposite sides of the islands as well (along the y axis), being more pronounced for  $T_g = 750^{\circ}$ C. This is clear in the local slope map displayed at the middle right panel inset of Fig. 2, a single pyramidal island zoomed out from Fig. 2c. Facet population data indicate that  $\sim 40\%$  of the total intensity corresponds to  $\{114\}$  facets, and  $\sim 40\%$ to {113} and {112} facets; therefore, the relative number of high-slope facets in the array is higher for this higher  $T_{g}$ value. Moreover, new facets appear for  $T_{\rm g} = 750^{\circ}{\rm C}$ (Fig. 2d) at very low-slope values  $(8^\circ)$ . They correspond to {119} planes near the top of the islands, as shown in Fig. 2 (middle and lower right panel insets). The formation of these {119} facets is presumably related to the increase in the mean island volume and facet slopes observed at this  $T_{\rm g}$ , when compared to the case of  $T_{\rm g} = 650^{\circ}$ C. Consider e.g. the two AFM topographic line-profiles (shown at the lower right inset of Fig. 2) across single representative islands within the arrays produced for each  $T_{\sigma}$ . These profiles, carried out along the fast scan direction, bring to view some of the differences in shape and size of the Si islands for each growth temperature.

It is important to mention that AFM measurements were also carried out for different experimental geometries (e.g. shifting by at least  $\approx \pi/4$  relative to the <110> directions the fast and slow scan directions in the AFM), obtaining similar results for facet types and population. We can therefore exclude that the asymmetry observed in the polar orientation maps (Fig. 2b, d) could originate in instrumental artefacts of the AFM measurements. Moreover, neither Si flux inhomogeneity during growth nor substrate miscut can respond for such asymmetry either: the first is ruled out using continuous substrate rotation during growth, while the substrate miscut has been checked to be random and well below specifications by X-ray diffraction azimuthal scans.

"Trench-like" features appear near the base of the pyramids in the line-profiles of Fig. 2. The 3D pictures displayed in Fig. 3, generated from AFM topography images, also illustrate the presence of these trenches (or depletion regions) around some of the islands for both growth temperatures. Trench formation has been reported for island arrays in different material systems, e.g. Ge and Si<sub>1-x</sub>Ge<sub>x</sub> alloys on Si(001), and has often been related to material transport processes from the substrate to the 3D islands [14, 15, 22]. Hence, one may wonder whether the asymmetry found in the surface orientation maps of Fig. 2, or the trenches observed in Fig. 3, could be related to similar mass



**Fig. 3** *Left*: island volume analysis for the pyramid arrays of Fig. 1, corresponding to nominally 5-nm thick Si layers grown at **a**  $T_g = 650^{\circ}$ C and **b**  $T_g = 750^{\circ}$ C on Si(001). Emergent volume versus flooding plane height,  $V_e$  vs. *c*, computed through the  $5 \times 5 \,\mu\text{m}^2$  images of Fig. 1 (also shown in the insets). Marked on the plots axes are the nominal deposited volume,  $V_0$ , (*continuous line*), same value in both plots; the total pyramids volume,  $V_{pyr}$  and the base plane height, *c'*, for each  $T_g$  (*dashed lines*). *Right*: 3D pictures generated from AFM topography images of the island arrays produced at each  $T_g$ , in order to highlight the trench formation phenomena. Note the different size of the two images:  $1 \times 1 \,\mu\text{m}^2$  for  $T_g = 650^{\circ}$ C and  $3 \times 3 \,\mu\text{m}^2$  for  $T_g = 750^{\circ}$ C

transport phenomena. To investigate this issue, we have estimated the quantity  $V_{pyr}$ , the volume of the islands present in a given AFM image, comparing it with  $V_0$ , the expected nominal volume of the Si layer deposited. The topographic *mold* of the mathematical formalism described in section "Local Slope Evaluation Formalism" was used for such calculations. In the limit of low-slope values  $(0.1^{\circ}-0.5^{\circ} \text{ angles})$ , the *interface volume* of a layer is approximated as  $V_{interface} = \sum_{\mathbf{r}} h_{\mathbf{r}} \cdot \Delta$  (being  $h_{\mathbf{r}}$  the local height averaged over the pixel area,  $\Delta$ ). The contribution of the islands to  $V_{\text{interface}}$  was obtained by a classical flooding procedure. The emergent volume over a flooding plane of height c is defined as  $V_e(\mathbf{r}, c) = \sum_{\mathbf{r}} H(h_{\mathbf{r}} - c)(h_{\mathbf{r}} - c)\Delta$ , being H(x) the Heaviside function.<sup>1</sup> Then, denoting as c' the height of the substrate surface plane (plane containing the base of the pyramids), different scenarios can be considered. For c = 0,  $V_e = V_{interface}$ . For c < c', a linear decrease in  $V_e$  is expected, whereas the linearity is lost when c > c'. Thus,  $V_{pyr}$  can be obtained after determining the c' value by interpolation of the  $V_{e}(c)$  curve.

The plots of the emergent volume ( $V_e$ ) with the flooding height *c* are shown in the left panels of Fig. 3 for two AFM

images of island arrays grown at  $T_g = 650$  (Fig. 3a) and  $T_{\rm g} = 750^{\circ}$ C (Fig. 3b). The AFM images analyzed, both of the same size  $(L_x \cdot L_y) = 5 \times 5 \ \mu m^2$ , are those of Fig. 1 (shown again in the insets of Fig. 3). The values of c' and  $V_{pvr}$  obtained in each case have been marked in the figure. The nominal volume of the deposited Si layers (having a nominal thickness t = 5 nm) for a given AFM image is simply calculated as  $V_0 = (L_x \cdot L_y) \cdot t$ . Remarkably, such value is significantly lower than the total island volume estimated from the data of Fig. 3, and the same occurs for diverse AFM images analyzed and for both substrate temperatures, although  $V_{pyr} - V_0$  is found to be larger for the highest  $T_{g}$ . In particular, for the AFM images of Fig. 3, we find:  $V_0 \cong 0.3 V_{pyr}$  for  $T_g = 650^{\circ}$ C, and  $V_0 \cong 0.2 V_{pyr}$ for  $T_{\rm g} = 750^{\circ}$ C. Our results indicate that the pyramid-like islands of these arrays are not only formed by the incoming Si flux but also by Si atoms from the Si (001) substrate. Although we do not know yet which are the driving forces neither for the formation of 3D islands in the Si/Si(001) system nor for the mass transport from the substrate surface to the pyramid flanks, it is expected that material transport would be enhanced for higher substrate temperatures, because of the higher mobility of Si atoms. Such assumption is in agreement with the stronger effect (higher excess volume) found for  $T_{\rm g} = 750^{\circ}$ C relative to  $T_{\rm g} = 650^{\circ}$ C. Once accepted that mass flow from the substrate surface to the 3D islands exists, it is reasonable to assume that the trench formation phenomena observed in these Si island arrays are related to the mass transport process. Indeed, the asymmetry in the  $N_{f}(m)$  distributions could also be related to it. For instance, if the transport of the Si atoms from the substrate to the islands is not uniform, facets with different slope values could develop at selected directions. In such case, the asymmetry observed in Fig. 2 could be interpreted as linked to preferential diffusion along one particular <110> direction. A complex combination of physical phenomena may stand behind the nucleation of finite size 3D nuclei in epitaxial growth, such as surface reactivity, growth kinetics, thermal stability or stress. There is a wide variety of materials reported, grown under rather heterogeneous conditions, in which extremely similar patterns develop, but identical morphologies may originate in diverse systems with excluding physical mechanisms. Even just during post-growth annealing, asymmetric surfacemediated alloying processes (a complex combination of mass transport, trench formation and diffusion anisotropy) has been pointed out in the Si-Ge system to produce asymmetric island shapes and composition profiles, leading to larger slope facets in one of the island sides [23, 24].

The formation of the pyramid arrays during homoepitaxial growth carried out under quasi-optimal (high adatom mobility) conditions, such as the samples analyzed here, is still an intriguing issue. Further experiments are needed to

<sup>&</sup>lt;sup>1</sup> H(x) = 0 for x < 0 and H(x) = 1 for x >; the c range is defined as  $0 < c < \text{Max}[h_r]$ 

identify the origin of these large-scale arrays in order to achieve full control of the phenomena involved and be able to customize the nanostructuring of the substrate. To help in those future experiments, the exhaustive analysis of surface morphology images possible through the formalism used along this work will certainly provide valuable global information, thus becoming an efficient tool for the investigation of the leading mechanisms involved.

# Conclusions

In summary, we have shown that the image processing procedures presented here are useful tools to perform statistical analysis over large area AFM images of nanostructures arrays and may be of valuable application in the study of self-assembling systems and processes. Using them along this work to analyze Si pyramid arrays grown by MBE at two different substrate temperatures, we have shown the occurrence of a remarkable asymmetry in the inplane distributions of lateral facets and their relative population along two orthogonal <110> directions. A detailed study of the different distributions found for each substrate temperature during growth is presented. Results also suggest transport of material from the substrate surface to the 3D islands, a process presumably related to the presence of trenches around some of the pyramids.

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